

RIBBON CABLE CONNECTORS



✓ Active

TE CONNECTIVITY (TE)

040 UNIV HDR SP 4S 30DP STD L1

AMP-LATCH | Universal Headers

102321-9

TE Internal Number: 102321-9

Not EU RoHS Compliant

Not Yet Reviewed for EU ELV

Connector System Board-to-Board **Number of Positions** 40

Centerline (Pitch) 2.54 mm [.1 in]

PCB Mount Retention Without

PCB Mount Retention Type Screw Mount



PRODUCT DRAWING

English



★ 3D PDF

DOCUMENTATION

Product Drawings

HEADER ASSY, UNIVERSAL, AMP-LATCH

PDF

English

CAD Files

Customer View Model

3D_IGS.ZIP

English

Customer View Model

3D_STP.ZIP

English

2D_DXF.ZIP English
English Control of the Control of th
3D PDF
PDF
English
Product Specifications
Product Specification
AMP-LATCH And IDC Header Connectors, .100 X .100 Inch Grid PDF
English
Qualification Test Report
Connector, AMP-LATCH Header, .100 X .100 Inch Grid
PDF English
English
Product Environmental Compliance
TE Material Declaration
MD_102321-9_012420171122_dmtec
PDF English
Instruction Sheets
Instruction Sheet (U.S.)
AMP INSTALLATION PROCEDURES FOR AMP-LATCH UNIVERSAL HEADER ASSEMBLIE
PDF
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AMP INSTALLATION PROCEDURES FOR AMP-LATCH UNIVERSAL HEADER ASSEMBLIE
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FEATURES
Please review product documents or contact us for the latest agency approval information.
Please Note: Use the Product Drawing for all design activity.
Product Type Features

Customer View Model

Header Type Universal Ejection Pin Headers

Connector System Board-to-Board

PCB Mounting Orientation Vertical

Shrouded Yes

Row-to-Row Spacing 2.54 mm [.1 in]

Connector Style Receptacle

Profile Standard

Connector & Contact Terminates To Printed Circuit Board

Connector Type Header

Board Standoff Without

Latch Type Long

Product Type Connector

Configuration Features

Number of Positions 40

Number of Rows 2

Ejection Latches With

Electrical Characteristics

Operating Voltage (VAC) 250

Insulation Resistance (M Ω) 5000

Body Features

Post Size .64 mm [.025 in]

Daisy Chain Without

Contact Features

Solder Tail Contact Plating Material Tin-Lead over Nickel

Contact Shape Square

Contact Current Rating (Max) (A) 1

Contact Mating Area Plating Material Gold Flash over Palladium Nickel, Gold

Contact Type Pin

Contact Termination Area Plating Thickness 2.54 µm [100 µin]

Contact Transmits (Typical) Signal (Data)

Contact Design Solder Dip

Contact Termination Area Plating Material Gold Flash over Palladium Nickel

Contact Mating Area Plating Thickness (µin) 30

Termination Features

Termination Method to PC Board Through Hole - Solder

Termination Post Length 3.94 mm [.155 in]

Mechanical Attachment

Panel Mount Retention Without

PCB Mount Alignment With

PCB Mount Retention Without

PCB Mount Retention Type Screw Mount

Mating Alignment Type Center, Dual Polarizing Bar

Mating Connector Lock With

Mating Connector Lock Type Latch

Mating Alignment With

Mating Retention Without

Polarization With

Housing Features Centerline (Pitch) 2.54 mm [.1 in] Housing Material Thermoplastic Housing Color Black Housing Style 4-Sided	
Dimensions	
Shrouded End Dimension 3.81 mm [.15 in] PCB Thickness (Recommended) 3.18 mm [.125 in] Height 8.53 mm [.34 in] Length 70.1 mm [2.76 in]	
Usage Conditions	
Operating Temperature Range (°C) -65 – 105 Temperature Rating Standard	
Industry Standards	
UL Flammability Rating UL 94V-0	
Packaging Features	
Packaging Method Tray Packaging Quantity 24	
PRODUCT COMPLIANCE	+
Statement of Compliance	
Statement of Compliance PDF	